imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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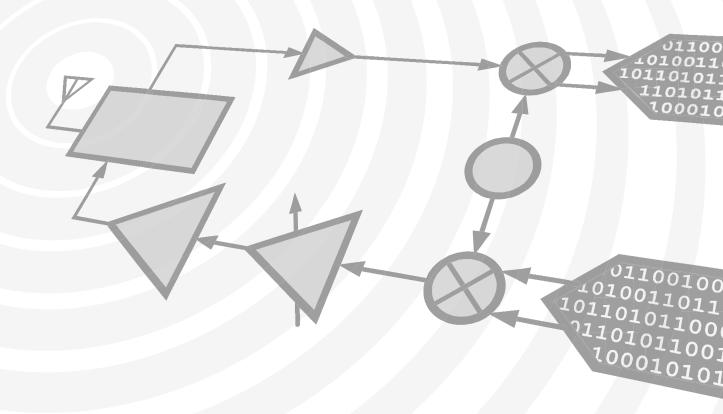






Analog Devices Welcomes Hittite Microwave Corporation

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Facilities, Manufacturing & Test

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- Class 100 Environment for S-Level Products
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- ♦ IR Reflow Equipment for PCB Based Assemblies
- ♦ Automated Digital Product Test to 40 Gbps
- Automated RF, Microwave & Millimeterwave Product Test to 110 GHz





High Reliability Screening & Tests

- Wafer Lot Acceptance Test (WLAT) Bond Pull & Die Shear SEM Inspection Metal & Dielectric Thickness Meas.
- ♦ Temperature Cycle
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- High Temp Burn-In
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- ♦ Fine & Gross Hermeticity
- ♦ Radiographic Inspection
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- Serialized Test Data
- Qualification Report

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Military Qualified Components, Modules & Subsystems!

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Chip (Die)



Dielectric Resonator Oscillator



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Switched Filter Bank





Multi-Channel Downconverter



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FET Channel SEM

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- Automatic Hybrid Assembly Equipment: Die Inspect/Pick, Die/Substrate Attach & Wire Bond
- IR Reflow Equipment for PCB Based Assemblies
- Automated Digital Product Test to 40 Gbps
- ♦ Automated RF, Microwave & Millimeterwave Product Test to 110 GHz







Class S Screening & Qualification

- ♦ VI to Methods 2010A & 2017K
- ♦ Temperature Cycle
- ♦ High Temperature Burn-In & Life Test
- Wafer Lot Acceptance Test Bond Pull & Die Shear SEM Inspection Metal & Dielectric Thickness Meas.
- Serialized Test Data
- Qualification Report

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